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Details

Product Status	Not For New Designs
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	SCI
Peripherals	LVD, POR, PWM
Number of I/O	13
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	192 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 4x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	16-SOIC (0.295", 7.50mm Width)
Supplier Device Package	16-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc908kx8cdwer2

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong





MC68HC908KX8 MC68HC908KX2 MC68HC08KX8

Data Sheet

To provide the most up-to-date information, the revision of our documents on the World Wide Web will be the most current. Your printed copy may be an earlier revision. To verify you have the latest information available, refer to:

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MC68HC908KX8 • MC68HC908KX2 • MC68HC08KX8 Data Sheet, Rev. 2.1

Freescale Semiconductor



Revision History

The following revision history table summarizes changes contained in this document. For your convenience, the page number designators have been linked to the appropriate location.

Revision History

Date	Revision Level	Description	Page Number(s)
		Label for pin 9 corrected in Figure 1-1 and Figure 1-2	19, 20
April, 2001		\$FF is the erase state of the FLASH, not \$00.	82, 252, 255
		First bulleted paragraph under the subsection 15.5 Interrupts reworded for clarity	177
	0.1	Revision to the description of the CHxMAX bit and the note that follows that description	183
		Forced monitor mode information added to Table 16-1.	192
		In Figure 16-10. Monitor Data Format, resistor value for connection between VTST and IRQ1 changed from 10 k Ω to 1 k Ω .	194
		7.2 Features — Corrected third bullet	71
		7.7.3 ICG Trim Register — Corrected description of the TRIM7:TRIM0 bits	97
		14.2 Features — Corrected divide by factors in first bullet	165
	1.0	Figure 14-1. Timebase Block Diagram — Corrected divide-by-2 blocks	166
February, 2002		Table 14-1. Timebase Divider Selection — Corrected last divider tap entry	167
		Section 15. Timer Interface Module (TIM) — Timer discrepancies corrected throughout this section	169
		17.4 Thermal Characteristics — Corrected SOIC thermal resistance and maximum junction temperature	202
		17.5 5.0-Vdc DC Electrical Characteristics and — Corrected footnote for VDD supply current in stop mode	203 and 204
		Appendix B. MC68HC08KX8 — Added to supply exception information for the MC68HC08KX8	215
		Reformatted to current publication standards	Throughout
		2.7 FLASH Page Erase Operation — Updated procedure	33
		2.8 FLASH Mass Erase Operation — Updated procedure	33
		2.9 FLASH Program/Read Operation — Updated procedure	34
March		Figure 5-1. COP Block Diagram — Updated figure	53
2004	2.0	Table 6-1. Instruction Set Summary — Added WAIT instruction	69
		Section 7. Internal Clock Generator Module (ICG) — Updated with new information	71 through 98
		14.2 Features — Corrected values given in the first bullet	165
		Table 15-3. Mode, Edge, and Level Selection — Reworked for clarity	182
		17.11 Memory Characteristics — Updated table with new information	210
July, 2005	2.1	Updated to meet Freescale identity guidelines.	Throughout



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Analog-to-Digital Converter (ADC)

The ADC requires a clock rate of approximately 1 MHz for correct operation. If the selected clock source is not fast enough, the ADC will generate incorrect conversions. See 17.9 Trimmed Accuracy of the Internal Clock Generator.

 $f_{ADIC} = \frac{f_{CGMXCLK} \text{ or bus frequency}}{ADIV[2:0]} \cong 1 \text{ MHz}$

NOTE

During the conversion process, changing the ADC clock will result in an incorrect conversion.

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Central Processor Unit (CPU)

Table 6-2. Opcode Map

	Bit Mani	pulation	Branch			Read-Mod	dify-Write			• Con	trol	İ			Register	/Memory			
	DIR	DIR	REL	DIR	INH	INH	IX1	SP1	IX	INH	INH	IMM	DIR	EXT	IX2	SP2	IX1	SP1	IX
MSB LSB	0	1	2	3	4	5	6	9E6	7	8	9	Α	В	С	D	9ED	E	9EE	F
0	5 BRSET0 3 DIR	4 BSET0 2 DIR	3 BRA 2 REL	4 NEG 2 DIR	1 NEGA 1 INH	1 NEGX 1 INH	4 NEG 2 IX1	5 NEG 3 SP1	3 NEG 1 IX	7 RTI 1 INH	3 BGE 2 REL	2 SUB 2 IMM	3 SUB 2 DIR	4 SUB 3 EXT	4 SUB 3 IX2	5 SUB 4 SP2	3 SUB 2 IX1	4 SUB 3 SP1	2 SUB 1 IX
1	5 BRCLR0 3 DIR	4 BCLR0 2 DIR	3 BRN 2 REL	5 CBEQ 3 DIR	4 CBEQA 3 IMM	4 CBEQX 3 IMM	5 CBEQ 3 IX1+	6 CBEQ 4 SP1	4 CBEQ 2 IX+	4 RTS 1 INH	3 BLT 2 REL	2 CMP 2 IMM	3 CMP 2 DIR	4 CMP 3 EXT	4 CMP 3 IX2	5 CMP 4 SP2	3 CMP 2 IX1	4 CMP 3 SP1	2 CMP 1 IX
2	5 BRSET1 3 DIR	4 BSET1 2 DIR	3 BHI 2 REL		5 MUL 1 INH	7 DIV 1 INH	3 NSA 1 INH		2 DAA 1 INH		3 BGT 2 REL	2 SBC 2 IMM	3 SBC 2 DIR	4 SBC 3 EXT	4 SBC 3 IX2	5 SBC 4 SP2	3 SBC 2 IX1	4 SBC 3 SP1	2 SBC 1 IX
3	5 BRCLR1 3 DIR	4 BCLR1 2 DIR	3 BLS 2 REL	COM 2 DIR	1 COMA 1 INH	1 COMX 1 INH	4 COM 2 IX1	5 COM 3 SP1	3 COM 1 IX	9 SWI 1 INH	3 BLE 2 REL	CPX 2 IMM	3 CPX 2 DIR	CPX 3 EXT	4 CPX 3 IX2	5 CPX 4 SP2	3 CPX 2 IX1	4 CPX 3 SP1	2 CPX 1 IX
4	5 BRSET2 3 DIR	4 BSET2 2 DIR	3 BCC 2 REL	4 LSR 2 DIR	1 LSRA 1 INH	1 LSRX 1 INH	4 LSR 2 IX1	5 LSR 3 SP1	3 LSR 1 IX	2 TAP 1 INH	2 TXS 1 INH	2 AND 2 IMM	3 AND 2 DIR	4 AND 3 EXT	4 AND 3 IX2	5 AND 4 SP2	3 AND 2 IX1	4 AND 3 SP1	2 AND 1 IX
5	5 BRCLR2 3 DIR	4 BCLR2 2 DIR	3 BCS 2 REL	4 STHX 2 DIR	3 LDHX 3 IMM	4 LDHX 2 DIR	3 CPHX 3 IMM		4 CPHX 2 DIR	1 TPA 1 INH	2 TSX 1 INH	2 BIT 2 IMM	3 BIT 2 DIR	BIT 3 EXT	4 BIT 3 IX2	5 BIT 4 SP2	3 BIT 2 IX1	4 BIT 3 SP1	2 BIT 1 IX
6	5 BRSET3 3 DIR	4 BSET3 2 DIR	3 BNE 2 REL	4 ROR 2 DIR	1 RORA 1 INH	1 RORX 1 INH	4 ROR 2 IX1	80R 3 SP1	3 ROR 1 IX	2 PULA 1 INH		2 LDA 2 IMM	3 LDA 2 DIR	4 LDA 3 EXT	4 LDA 3 IX2	5 LDA 4 SP2	3 LDA 2 IX1	4 LDA 3 SP1	2 LDA 1 IX
7	5 BRCLR3 3 DIR	4 BCLR3 2 DIR	3 BEQ 2 REL	4 ASR 2 DIR	1 ASRA 1 INH	1 ASRX 1 INH	4 ASR 2 IX1	5 ASR 3 SP1	3 ASR 1 IX	2 PSHA 1 INH	1 TAX 1 INH	AIS 2 IMM	3 STA 2 DIR	STA 3 EXT	4 STA 3 IX2	5 STA 4 SP2	3 STA 2 IX1	4 STA 3 SP1	2 STA 1 IX
8	5 BRSET4 3 DIR	4 BSET4 2 DIR	3 BHCC 2 REL	4 LSL 2 DIR	1 LSLA 1 INH	1 LSLX 1 INH	4 LSL 2 IX1	5 LSL 3 SP1	3 LSL 1 IX	2 PULX 1 INH	1 CLC 1 INH	EOR 2 IMM	3 EOR 2 DIR	EOR 3 EXT	4 EOR 3 IX2	5 EOR 4 SP2	3 EOR 2 IX1	4 EOR 3 SP1	EOR 1 IX
9	5 BRCLR4 3 DIR	4 BCLR4 2 DIR	3 BHCS 2 REL	4 ROL 2 DIR	1 ROLA 1 INH	1 ROLX 1 INH	4 ROL 2 IX1	80L 3 SP1	3 ROL 1 IX	PSHX 1 INH	1 SEC 1 INH	ADC 2 IMM	3 ADC 2 DIR	ADC 3 EXT	4 ADC 3 IX2	ADC 4 SP2	3 ADC 2 IX1	4 ADC 3 SP1	ADC 1 IX
A	5 BRSET5 3 DIR	4 BSET5 2 DIR	3 BPL 2 REL	4 DEC 2 DIR	1 DECA 1 INH	1 DECX 1 INH	4 DEC 2 IX1	5 DEC 3 SP1	3 DEC 1 IX	2 PULH 1 INH	2 CLI 1 INH	2 ORA 2 IMM	3 ORA 2 DIR	4 ORA 3 EXT	4 ORA 3 IX2	5 ORA 4 SP2	3 ORA 2 IX1	4 ORA 3 SP1	2 ORA 1 IX
в	5 BRCLR5 3 DIR	4 BCLR5 2 DIR	3 BMI 2 REL	5 DBNZ 3 DIR	3 DBNZA 2 INH	3 DBNZX 2 INH	5 DBNZ 3 IX1	6 DBNZ 4 SP1	4 DBNZ 2 IX	2 PSHH 1 INH	2 SEI 1 INH	2 ADD 2 IMM	3 ADD 2 DIR	4 ADD 3 EXT	4 ADD 3 IX2	5 ADD 4 SP2	3 ADD 2 IX1	4 ADD 3 SP1	2 ADD 1 IX
с	5 BRSET6 3 DIR	4 BSET6 2 DIR	3 BMC 2 REL	4 INC 2 DIR	1 INCA 1 INH	1 INCX 1 INH	4 INC 2 IX1	5 INC 3 SP1	3 INC 1 IX	1 CLRH 1 INH	1 RSP 1 INH		2 JMP 2 DIR	3 JMP 3 EXT	4 JMP 3 IX2		3 JMP 2 IX1		2 JMP 1 IX
D	5 BRCLR6 3 DIR	4 BCLR6 2 DIR	3 BMS 2 REL	3 TST 2 DIR	1 TSTA 1 INH	1 TSTX 1 INH	3 TST 2 IX1	4 TST 3 SP1	2 TST 1 IX		1 NOP 1 INH	4 BSR 2 REL	4 JSR 2 DIR	5 JSR 3 EXT	6 JSR 3 IX2		5 JSR 2 IX1		4 JSR 1 IX
E	5 BRSET7 3 DIR	4 BSET7 2 DIR	3 BIL 2 REL		5 MOV 3 DD	4 MOV 2 DIX+	4 MOV 3 IMD		4 MOV 2 IX+D	1 STOP 1 INH	*	2 LDX 2 IMM	3 LDX 2 DIR	4 LDX 3 EXT	4 LDX 3 IX2	5 LDX 4 SP2	3 LDX 2 IX1	4 LDX 3 SP1	2 LDX 1 IX
F	5 BRCLR7 3 DIR	4 BCLR7 2 DIR	3 BIH 2 REL	3 CLR 2 DIR	1 CLRA 1 INH	1 CLRX 1 INH	3 CLR 2 IX1	4 CLR 3 SP1	CLR 1 IX	1 WAIT 1 INH	1 TXA 1 INH	AIX 2 IMM	STX 2 DIR	STX 3 EXT	4 STX 3 IX2	5 STX 4 SP2	3 STX 2 IX1	4 STX 3 SP1	STX 1 IX

INH Inherent IMM Immediate REL Relative IX Indexed, No Offset DIR Direct EXT Extended IX1 IX2 DD Direct-Direct IX+D Indexed-Direct

- Indexed, 8-Bit Offset Indexed, 16-Bit Offset
- IMD Immediate-Direct DIX+ Direct-Indexed

SP1 Stack Pointer, 8-Bit Offset SP2 Stack Pointer, 16-Bit Offset IX+ Indexed, No Offset with

- Post Increment IX1+ Indexed, 1-Byte Offset with Post Increment



0 High Byte of Opcode in Hexadecimal

0

MSB

LSB

5 Cycles BRSET0 Opcode Mnemonic 3 DIR Number of Bytes / Addressing Mode

*Pre-byte for stack pointer indexed instructions





7.3.4 Clock Monitor Circuit

The ICG contains a clock monitor circuit which, when enabled, will continuously monitor both the external clock (ECLK) and the internal clock (ICLK) to determine if either clock source has been corrupted. The clock monitor circuit, shown in Figure 7-4, contains these blocks:

- Clock monitor reference generator
- Internal clock activity detector
- External clock activity detector



Figure 7-4. Clock Monitor Block Diagram

7.3.4.1 Clock Monitor Reference Generator

The clock monitor uses a reference based on one clock source to monitor the other clock source. The clock monitor reference generator generates the external reference clock (EREF) based on the external clock (ECLK) and the internal reference clock (IREF) based on the internal clock (ICLK). To simplify the circuit, the low frequency base clock (IBASE) is used in place of ICLK because it always operates at or



Internal Clock Generator Module (ICG)

DSTG7:DSTG0 — ICG DCO Stage Control Bits

These bits indicate the number of stages (above the minimum) in the digitally controlled oscillator. The total number of stages is approximately equal to \$1FF, so changing DSTG from \$00 to \$FF will approximately double the period. Incrementing DSTG will increase the period (decrease the frequency) by 0.202% to 0.368% (decrementing has the opposite effect). DSTG cannot be written when ICGON is set to prevent inadvertent frequency shifting. When ICGON is set, DSTG is controlled by the digital loop filter. Since the DCO is active during reset, reset has no effect on DSTG and the value may vary.



Keyboard Interrupt Module (KBI)

9.6.2 Keyboard Interrupt Enable Register

The keyboard interrupt enable register (KBIER) enables or disables each port A pin to operate as a keyboard interrupt pin.



Figure 9-5. Keyboard Interrupt Enable Register (KBIER)

KBIE4–KBIE0 — Keyboard Interrupt Enable Bits

Each of these read/write bits enables the corresponding keyboard interrupt pin to latch interrupt requests. Reset clears the keyboard interrupt enable register.

1 = PAx pin enabled as keyboard interrupt pin

0 = PAx pin not enabled as keyboard interrupt pin



Chapter 10 Low-Voltage Inhibit (LVI)

10.1 Introduction

This section describes the low-voltage inhibit (LVI) module, which monitors the voltage on the V_{DD} pin and can force a reset when the V_{DD} voltage falls below the LVI trip falling voltage, V_{TRIPF} .

10.2 Features

Features of the LVI module include:

- Programmable LVI reset
- Programmable power consumption
- Selectable LVI trip voltage
- Programmable stop mode operation

10.3 Functional Description

Figure 10-1 shows the structure of the LVI module. LVISTOP, LVIPWRD, LVI5OR3, and LVIRSTD are user selectable options found in the configuration register (CONFIG1). See Chapter 4 Configuration Register (CONFIG).



Figure 10-1. LVI Module Block Diagram

The LVI is enabled out of reset. The LVI module contains a bandgap reference circuit and comparator. Clearing the LVI power disable bit, LVIPWRD, enables the LVI to monitor V_{DD} voltage. Clearing the LVI reset disable bit, LVIRSTD, enables the LVI module to generate a reset when V_{DD} falls below a voltage, V_{TRIPF} . Setting the LVI enable in stop mode bit, LVISTOP, enables the LVI to operate in stop mode.



These read/write bits control port A data direction. Reset clears DDRA4–DDRA0, configuring all port A pins as inputs.

- 1 = Corresponding port A pin configured as output
- 0 = Corresponding port A pin configured as input

NOTE

Avoid glitches on port A pins by writing to the port A data register before changing data direction register A bits from 0 to 1.

Figure 11-4 shows the port A I/O logic.



Figure 11-4. Port A I/O Circuit

When bit DDRAx is a 1, reading address \$0000 reads the PTAx data latch. When bit DDRAx is a 0, reading address \$0000 reads the voltage level on the pin. The data latch can always be written, regardless of the state of its data direction bit. Table 11-1 summarizes the operation of the port A pins.

Table 11-1. Port A Pin Functions

PTAPUE	DDRA	ΡΤΑ	I/O Pin	Accesses to DDRA	Access	es to PTA
Bit	Bit	Bit	Mode	Read/Write	Read	Write
1	0	Х	Input, V _{DD} ⁽¹⁾	DDRA4-DDRA0	Pin	PTA4-PTA0 ⁽²⁾
0	0	Х	Input, Hi-Z	DDRA4–DDRA0	Pin	PTA4–PTA0 ⁽³⁾
Х	1	Х	Output	DDRA4-DDRA0	PTA4-PTA0	PTA4–PTA0

X = Don't care

Hi-Z = High impedance

1. I/O pin pulled up to V_{DD} by internal pullup device

2. Writing affects data register, but does not affect input.

11.2.3 Port A Input Pullup Enable Register

The port A input pullup enable register (PTAPUE) contains a software configurable pullup device for each of the five port A pins. Each bit is individually configurable and requires that the data direction register, DDRA, bit be configured as an input. Each pullup is automatically disabled when a port bit's DDRA is configured for output mode.



Input/Output (I/O) Ports (PORTS)





PTAPUE4–PTAPUE0 — Port A Input Pullup Enable Bits

These writable bits are software programmable to enable pullup devices on an input port bit.

1 = Corresponding port A pin configured to have internal pullup

0 = Corresponding port A pin has internal pullup disconnected

11.3 Port B

Port B is an 8-bit special-function port that shares four of its pins with the analog-to-digital converter module (ADC), two with the serial communication interface module (SCI) and two with an optional external clock source.

11.3.1 Port B Data Register

The port B data register (PTB) contains a data latch for each of the eight port B pins.



Figure 11-6. Port B Data Register (PTB)

PTB7-PTB0 — Port B Data Bits

These read/write bits are software-programmable. Data direction of each port B pin is under the control of the corresponding bit in data direction register B. Reset has no effect on port B data.

OSC2 and OSC1 — OSC2 and OSC1 Bits

Under software control, PTB7 and PTB6 can be configured as external clock inputs and outputs. PTB7 will become an output clock, OSC2, if selected in the configuration registers and enabled in the ICG registers. PTB6 will become an external input clock source, OSC1, if selected in the configuration registers and enabled in the ICG registers. See Chapter 7 Internal Clock Generator Module (ICG) and Chapter 4 Configuration Register (CONFIG).

RxD — SCI Receive Data Input Bit

The PTB1/RxD pin is the receive data input for the SCI module. When the enable SCI bit, ENSCI, is clear, the SCI module is disabled, and the PTB1/RxD pin is available for general-purpose I/O. See Chapter 12 Serial Communications Interface Module (SCI).



the SCDR. Once cleared, BKF can become set again only after 1s again appear on the RxD pin followed by another break character. Reset clears the BKF bit.

1 = Break character detected

0 = No break character detected

RPF — Reception-in-Progress Flag Bit

This read-only bit is set when the receiver detects a 0 during the RT1 time period of the start bit search. RPF does not generate an interrupt request. RPF is reset after the receiver detects false start bits (usually from noise or a baud rate mismatch), or when the receiver detects an idle character. Polling RPF before disabling the SCI module or entering stop mode can show whether a reception is in progress.

1 = Reception in progress

0 = No reception in progress

12.7.6 SCI Data Register

The SCI data register (SCDR) is the buffer between the internal data bus and the receive and transmit shift registers. Reset has no effect on data in the SCI data register.

Address:	\$0018							
	Bit 7	6	5	4	3	2	1	Bit 0
Read:	R7	R6	R5	R4	R3	R2	R1	R0
Write:	T7	T6	T5	T4	Т3	T2	T1	Т0
Reset:	Unaffected by reset							

Figure 12-16. SCI Data Register (SCDR)

R7/T7–R0/T0 — Receive/Transmit Data Bits

Reading address \$0018 accesses the read-only received data bits, R7–R0. Writing to address \$0018 writes the data to be transmitted, T7–T0. Reset has no effect on the SCI data register.

NOTE Do not use read-modify-write instructions on the SCI data register.

12.7.7 SCI Baud Rate Register

The baud rate register (SCBR) selects the baud rate for both the receiver and the transmitter.





Serial Communications Interface Module (SCI)

SCP1 and SCP0 — SCI Baud Rate Prescaler Bits

These read/write bits select the baud rate prescaler divisor as shown in Table 12-6. Reset clears SCP1 and SCP0.

SCP[1:0]	Prescaler Divisor (PD)
00	1
01	3
10	4
11	13

Table 12-6. SCI Baud Rate Prescaling

SCR2–SCR0 — SCI Baud Rate Select Bits

These read/write bits select the SCI baud rate divisor as shown in Table 12-7. Reset clears SCR2–SCR0.

SCR[2:1:0]	Baud Rate Divisor (BD)
000	1
001	2
010	4
011	8
100	16
101	32
110	64
111	128

Table 12-7. SCI Baud Rate Selection

Use this formula to calculate the SCI baud rate:

Baud rate =
$$\frac{\text{fBAUDCLK}}{64 \times \text{PD} \times \text{BD}}$$

where:

 $f_{BAUDCLK}$ = baud clock frequency PD = prescaler divisor BD = baud rate divisor

Table 12-8 shows the SCI baud rates that can be generated with a 4.9152-MHz CGMXCLK frequency.



13.2 SIM Bus Clock Control and Generation

The bus clock generator provides system clock signals for the CPU and peripherals on the MCU. The system clocks are generated from an incoming clock, CGMOUT, as shown in Figure 13-3. This clock originates from either an external oscillator or from the internal clock generator.



Figure 13-3. System Clock Signals

13.2.1 Bus Timing

In user mode, the internal bus frequency is the internal clock generator output (CGMXCLK) divided by four.

13.2.2 Clock Startup from POR or LVI Reset

When the power-on reset (POR) module or the low-voltage inhibit (LVI) module generates a reset, the clocks to the CPU and peripherals are inactive and held in an inactive phase until after 4096 CGMXCLK cycles. The MCU is held in reset by the SIM during this entire period. The bus clocks start upon completion of the timeout.

13.2.3 Clocks in Stop Mode and Wait Mode

Upon exit from stop mode by an interrupt or reset, the SIM allows CGMXCLK to clock the SIM counter. The CPU and peripheral clocks do not become active until after the stop delay timeout. Stop mode recovery timing is discussed in detail in 13.6.2 Stop Mode.

In wait mode, the CPU clocks are inactive. Refer to the wait mode subsection of each module to see if the module is active or inactive in wait mode. Some modules can be programmed to be active in wait mode.



15.8 I/O Registers

These I/O registers control and monitor operation of the TIM:

- TIM status and control register (TSC)
- TIM control registers (TCNTH and TCNTL)
- TIM counter modulo registers (TMODH and TMODL)
- TIM channel status and control registers (TSC0 and TSC1)
- TIM channel registers (TCH0H and TCH0L, TCH1H and TCH1L)

15.8.1 TIM Status and Control Register

The TIM status and control register (TSC):

- Enables TIM overflow interrupts
- Flags TIM overflows
- Stops the TIM counter
- Resets the TIM counter
- Prescales the TIM counter clock



Figure 15-5. TIM Status and Control Register (TSC)

TOF — TIM Overflow Flag Bit

This read/write flag is set when the TIM counter reaches the modulo value programmed in the TIM counter modulo registers. Clear TOF by reading the TIM status and control register when TOF is set and then writing a 0 to TOF. If another TIM overflow occurs before the clearing sequence is complete, then writing 0 to TOF has no effect. Therefore, a TOF interrupt request cannot be lost due to inadvertent clearing of TOF. Reset clears the TOF bit. Writing a 1 to TOF has no effect.

1 = TIM counter has reached modulo value.

0 = TIM counter has not reached modulo value.

TOIE — **TIM** Overflow Interrupt Enable Bit

This read/write bit enables TIM overflow interrupts when the TOF bit becomes set. Reset clears the TOIE bit.

1 = TIM overflow interrupts enabled

0 = TIM overflow interrupts disabled

TSTOP — TIM Stop Bit

This read/write bit stops the TIM counter. Counting resumes when TSTOP is cleared. Reset sets the TSTOP bit, stopping the TIM counter until software clears the TSTOP bit.

1 = TIM counter stopped

0 = TIM counter active

NOTE

Do not set the TSTOP bit before entering wait mode if the TIM is required to exit wait mode.



16.2.1.3 TIM1 and TIM2 During Break Interrupts

A break interrupt stops the timer counters.

16.2.1.4 COP During Break Interrupts

The COP is disabled during a break interrupt when BDCOP bit is set in break auxiliary register (BRKAR).

16.2.2 Break Module Registers

These registers control and monitor operation of the break module:

- Break status and control register (BRKSCR)
- Break address register high (BRKH)
- Break address register low (BRKL)
- SIM break status register (SBSR)
- SIM break flag control register (SBFCR)

16.2.2.1 Break Status and Control Register

The break status and control register (BRKSCR) contains break module enable and status bits.



Figure 16-3. Break Status and Control Register (BRKSCR)

BRKE — Break Enable Bit

This read/write bit enables breaks on break address register matches. Clear BRKE by writing a 0 to bit 7. Reset clears the BRKE bit.

- 1 = Breaks enabled on 16-bit address match
- 0 = Breaks disabled on 16-bit address match

BRKA — Break Active Bit

This read/write status and control bit is set when a break address match occurs. Writing a 1 to BRKA generates a break interrupt. Clear BRKA by writing a 0 to it before exiting the break routine. Reset clears the BRKA bit.

1 = When read, break address match

0 = When read, no break address match



Monitor ROM (MON)

The MCU executes the SWI and PSHH instructions when it enters monitor mode. The RUN command tells the MCU to execute the PULH and RTI instructions. Before sending the RUN command, the host can modify the stacked CPU registers to prepare to run the host program. The READSP command returns the incremented stack pointer value, SP + 1. The high and low bytes of the program counter are at addresses SP + 5 and SP + 6.

	SP
HIGH BYTE OF INDEX REGISTER	SP + 1
CONDITION CODE REGISTER	SP + 2
ACCUMULATOR	SP + 3
LOW BYTE OF INDEX REGISTER	SP + 4
HIGH BYTE OF PROGRAM COUNTER	SP + 5
LOW BYTE OF PROGRAM COUNTER	SP + 6
	SP + 7

Figure 16-14. Stack Pointer at Monitor Mode Entry

16.3.2 Security

A security feature discourages unauthorized reading of FLASH locations while in monitor mode. The host can bypass the security feature at monitor mode entry by sending eight security bytes that match the bytes at locations \$FFF6–\$FFFD. Locations \$FFF6–\$FFFD contain user-defined data.

NOTE

Do not leave locations \$FFF6–\$FFFD blank. For security reasons, program locations \$FFF6–\$FFFD even if they are not used for vectors. If FLASH is erased, the eight security byte values to be sent to the MCU are \$FF, the unprogrammed state of the FLASH.

During monitor mode entry, a reset must be asserted. PTA1 must be held low during the reset and 24 CGMXCLK cycles after the end of the reset. Then the MCU will wait for eight security bytes on PTA0. Each byte will be echoed back to the host. See Figure 16-15.

If the received bytes match those at locations \$FFF6–\$FFFD, the host bypasses the security feature and can read all FLASH locations and execute code from FLASH. Security remains bypassed until a reset occurs. After any reset, security will be locked. To bypass security again, the host must resend the eight security bytes on PTA0.

If the received bytes do not match the data at locations \$FFF6-\$FFFD, the host fails to bypass the security feature. The MCU remains in monitor mode, but reading FLASH locations returns undefined data, and trying to execute code from FLASH causes an illegal address reset.



Chapter 18 Ordering Information and Mechanical Specifications

18.1 Introduction

This section contains ordering numbers for MC68HC908KX8 and MC68HC908KX2. Refer to Figure 18-1 for an example of the device numbering system.

In addition, this section gives the package dimensions for:

- 16-pin plastic dual in-line package (case number 648D)
- 16-pin small outline package (case number 751G)

18.2 MC Order Numbers

MC Order Number ⁽¹⁾	Operating Temperature Range
MC68HC908KX8CP MC68HC908KX8CDW	−40°C to +85°C
MC68HC908KX8VP MC68HC908KX8VDW	−40°C to +105°C
MC68HC908KX8MP MC68HC908KX8MDW	-40°C to +125°C
MC68HC908KX2CP MC68HC908KX2CDW	−40°C to +85°C
MC68HC908KX2VP MC68HC908KX2VDW	−40°C to +105°C
MC68HC908KX2MP MC68HC908KX2MDW	-40°C to +125°C

Table 18-1. MC Order Numbers

1. P = Plastic dual in-line package DW = Small outline package



Figure 18-1. Device Numbering System